

The listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1. (Currently Amended) A method for manufacturing a light emitting device by ~~zoning a first substrate into a plurality of blocks and zoning each block into a plurality of light emitting regions,~~ comprising the steps of:

~~a first step of~~ forming a plurality of light emitting regions and terminal portions over ~~[[the]]~~ a first substrate in a first place;

~~a second step of~~ sealing a light emitting element with a second substrate in the first place;

~~a third step of~~ removing one part of the second substrate overlapped with one part of a plurality of terminal portions by separating, and exposing the one part of the terminal portions in the first place;

~~a fourth step of~~ inspecting by applying a current only to the one part of the terminal portions in the first place;

~~a fifth step of~~ transporting from the first place to a second place,

~~a sixth step of~~ cutting off the first and the second substrates and dividing into each light emitting region in the second place; and

~~a seventh step of~~ attaching an FPC to a terminal portion connected to one light emitting region in the second place.

2. (Currently Amended) A method ~~for manufacturing a light emitting device~~ according to claim 1, wherein $n \times m$ ($n > 1$ and $m > 1$) light emitting regions are arranged in n lines and m columns in the first substrate.

3. (Currently Amended) A method for manufacturing a light emitting device by ~~zoning a first substrate into a plurality of blocks and zoning each block into a plurality of light emitting regions~~, comprising the steps of:

~~a first step of forming a plurality of light emitting regions and terminal portions over [[the]] a first substrate in a first place;~~

~~a second step of sealing a light emitting element with a second substrate in the first place;~~

~~a third step of dividing the first substrate in the first place;~~

~~a fourth step of removing one part of the second substrate overlapped with one part of a plurality of terminal portions by separating, and exposing the one part of the terminal portions in the first place;~~

~~a fifth step of inspecting by applying a current only to the one part of the terminal portions in the first place;~~

~~a sixth step of transporting from the first place to a second place,~~

~~a seventh step of cutting off the first and the second substrates and dividing into each light emitting region in the second place; and~~

~~an eighth step of attaching an FPC to a terminal portion connected to one light emitting region.~~

4. (Currently Amended) A method ~~for manufacturing a light emitting device according to any one of claim 1 to claim 3~~, wherein a plurality of light emitting elements and a plurality of TFTs are provided for the light emitting region.

5. (Currently Amended) A method ~~for manufacturing a light emitting device according to any one of claim 1 to claim 4~~, wherein the second substrate has the same size as that of the first substrate or smaller size than that of the first substrate.

6. (Currently Amended) A method ~~for manufacturing a light emitting device~~ according to ~~any one of claim 1 to claim 5~~, wherein the light emitting device is one of a video camera, digital camera, a display, a car navigation, a personal computer, ~~[[or]]~~ and a personal digital assistant.

7. (New) A method according to claim 3, wherein the plurality of light emitting elements and a plurality of TFTs are provided for the light emitting region.

8. (New) The method according to claim 3, wherein the second substrate has the same size as that of the first substrate or smaller size than that of the first substrate.

9. (New) A method according to claim 3, wherein the light emitting device is one of a video camera, digital camera, a display, a car navigation, a personal computer, and a personal digital assistant.